

## FH69 Series

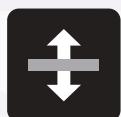
# 0.5mm Pitch, Height 2.3mm, Top and Bottom Contact, Backflip, 2-point Contact, 125 °C Compatible, FPC/FFC Connector



Flip-Lock Pioneer **Hirose**

P =  
**0.5**  
mm

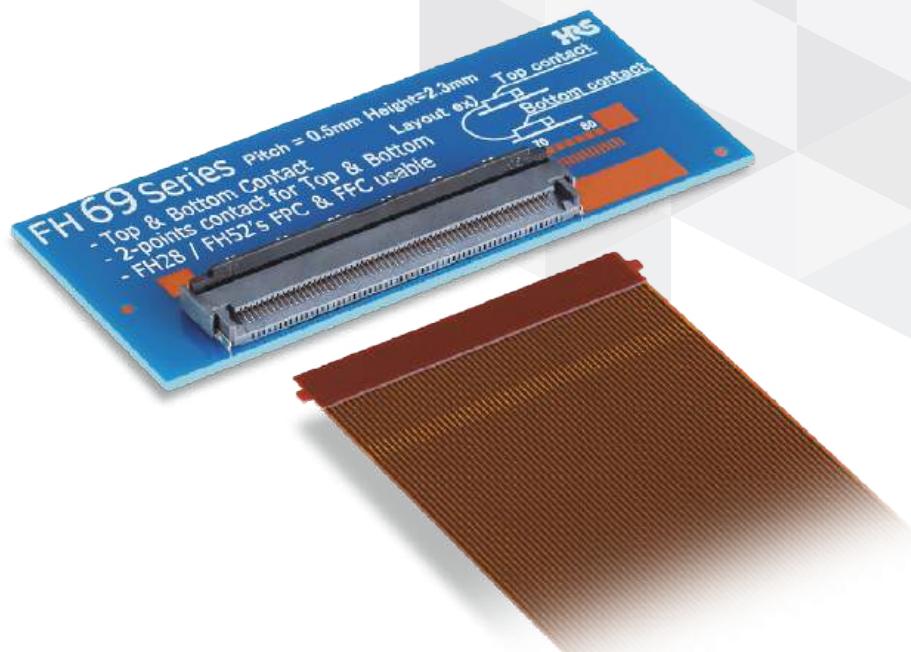
P = 0.5 mm



Top/Bottom Contact



Automotive



Product page

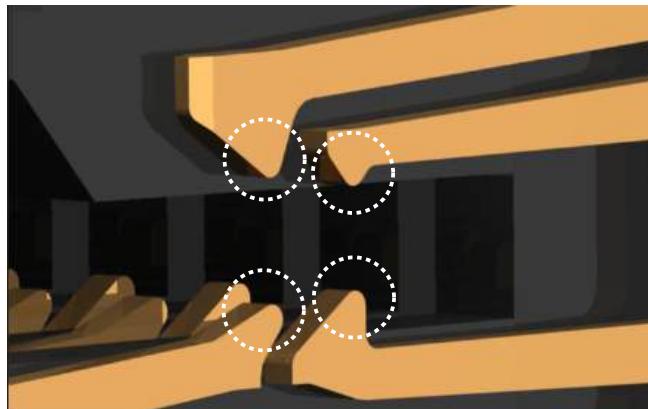
<https://www.hirose.com/en/product/series/FH69>

Jun. 2025

## Features

### 1. The industry's first top and bottom 2-point contacts design prevents dust intrusion.

The top and bottom two-point contacts with springs prevent dust intrusion and enhance contact reliability.

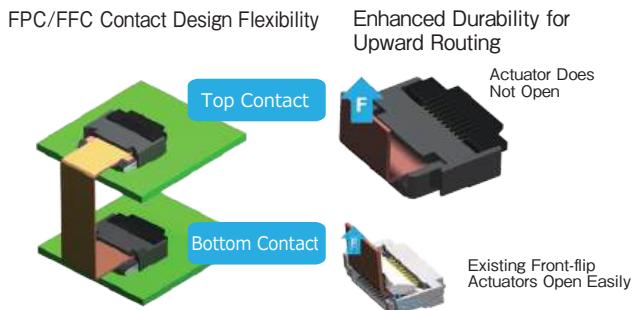


Top and bottom two-point contacts provide effective dust protection.

### 2. Greater Design Flexibility

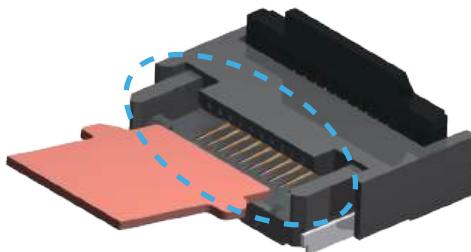
Can be used with both top and bottom contacts for enhanced product design.

Additionally, FH69's back flip design greatly increases the FPC/FFC retention force in the vertical direction.



### 3. Improved Workability

Even with the back-flip design, FH69 has a wide mating port like existing front-flip types for easy FPC/FFC insertion. Additionally, since the product is delivered with the actuator open, mating is completed in the two simple steps of 1. FPC/FFC insertion, and 2. Closing the actuator.



Wide Mating Port Even with Back-flip Design

### 4. FPC/FFC Mis-mating detection

Can detect mis-mating after FPC/FFC insertion by checking the location of the FPC/FFC tabs.

### 5. Reduced switching time

Suitable for the FPC/FFC and land patterns of 0.5mm pitch standard products FH28/FH28K/FH52E/FH52K/FH52T/FH75 for easy replacement when top contact or vertical routing are required.

\* Consult a Hirose representative about competitor products.

\* FH69 has a dedicated land pattern; however, the land patterns of the above 0.5mm pitch standard products can also be used with FH69.

### 6. 125°C Heat Resistance

Ideal for applications requiring 125°C heat resistance

\* When using FFC the heat resistance is up to 105°C. When the heat resistance of the FPC/FFC is less than 125°C for FPC and 105°C for FFC, the heat resistance of the FPC/FFC is applicable.

### 7. Passes Strict Automotive Testing Requirements

FH69 passes rigorous tests for various automotive applications.

(Ex. : Temperature Cycle)

Temperature : -55 → +15 to +35 → +125 → +15 to 35°C

Time : 30 → 2 to 3 → 30 → 2 to 3min.

1000 cycles repeated under the above conditions

### 8. Halogen-Free

No chlorine or bromine exceeding the standard value is used in the connector.

\* As defined by IEC61249-2-21

Br-900ppm maximum, Cl-900ppm maximum, Cl + Br combined-1,500ppm maximum

## Product Specifications

Rated Current	0.5A	Operating Temperature (Note 1)(Note 2)	-55 to +125°C
Rated Voltage	50V AC/DC	Operating Humidity Range	RH 90% Max. (No Condensation)
		Storage Temperature (Note 3)	-10 to +50°C
		Storage Humidity Range (Note 3)	RH 90% Max. (No Condensation)

Recommended FPC/FFC Specifications	t=0.3 ± 0.05mm, Gold Plated
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Item	Specifications	Conditions
Insulation Resistance	500M Ω Min.	Measured at 100V DC
Withstanding Voltage	No flashover or insulation breakdown	150V AC for 1 min.
Contact Resistance	Initial : 50m Ω , After Testing: 70m Ω Max. Includes FPC/FFC conductor resistance.	Measured at 1mA (DC or 1000Hz)
Mating Durability	Contact Resistance : 70m Ω Max. No damage, cracks or part dislocation.	10 times
Vibration Resistance	No electrical discontinuity of 1 μ s Min. Contact Resistance : 70m Ω Max. No damage, cracks or part dislocation.	Frequency : 10 to 55 Hz, single amplitude of 0.75mm, 10 cycles in each of the 3 axis
Shock Resistance	No electrical discontinuity of 1 μ s Min. Contact Resistance : 70m Ω Max. No damage, cracks or part dislocation.	Acceleration of 981m/s <sup>2</sup> , 6 ms duration, sine halfwave, 3 cycles in each of the 3 axis
Steady-state Moisture Resistance	Contact Resistance : 70m Ω Max. Insulation Resistance : 50M Ω Min. No damage, cracks or part dislocation.	Left for 1000 hours at 60°C and humidity of 90 to 95%
Temperature Cycle	Contact Resistance : 70m Ω Max. Insulation Resistance : 50M Ω Min. No damage, cracks or part dislocation.	Temperature : -55 → +15 to +35 → +125 → +15 to +35°C Time : 30 → 2 to 3 → 30 → 2 to 3 minutes Above conditions repeated for 5 cycles
Solder Heat Resistance	No deformation in appearance or significant damage to contacts.	Reflow : At the recommended temperature profile Manual soldering : 400°C ± 10°C for 5 seconds

Note 1 : Includes the temperature rise due to current flow.

Note 2 : When using FFC the heat resistance is up to 105°C . When the heat resistance of the FPC/FFC is less than 125°C for FPC and 105°C for FFC, the heat resistance of the FPC/FFC is applicable.

Note 3 : Storage refers to long-term storage of products before board mounting. The operating temperature and humidity apply to the non-energized state after mounting.

## Material and Finish

Component	Material	Finish/Remarks
Insulation Case	LCP	Gray
Actuator	PA 9T	Black
Contact	Copper Alloy	Partially Gold Plated
Retention Tab	Brass	Pure Tin Reflow Plating

## Part Number Structure

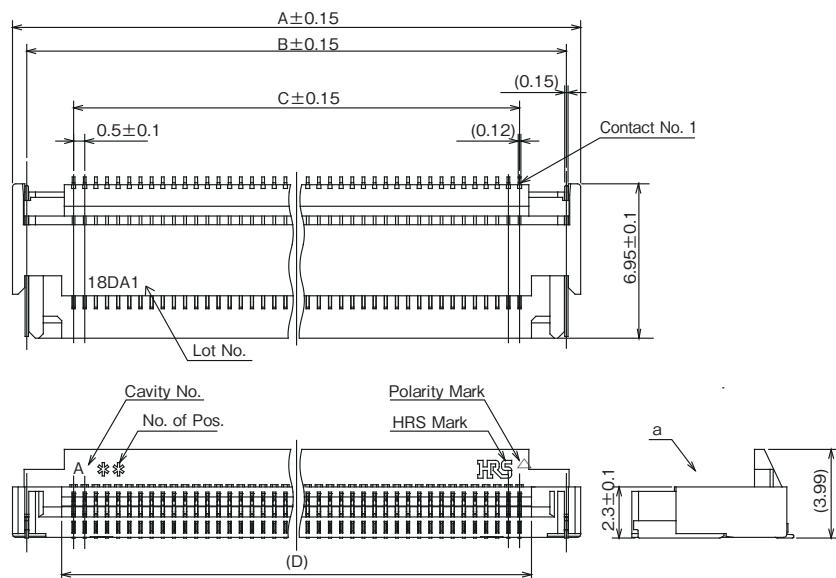
Refer to the chart below when determining the product specifications from the product number.  
Please select from the product numbers listed in this catalog when placing orders.

**FH69 - ##S - 0.5 SH (##)**

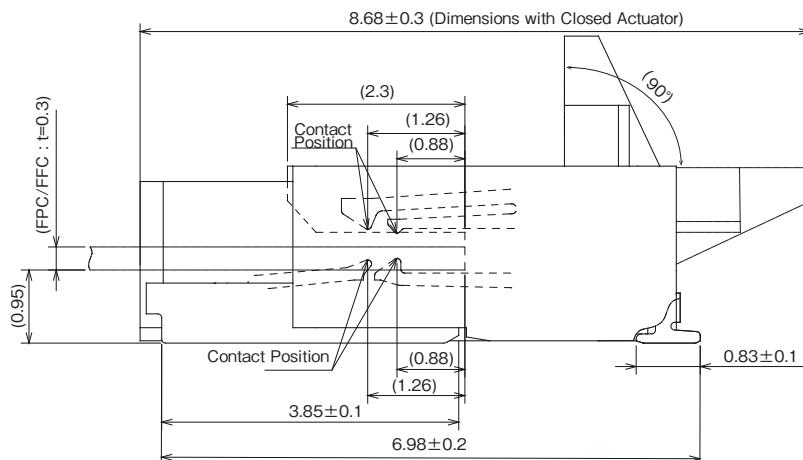
1 2 3 4 5

1 Series Name	FH69	4 Termination Type	SH : SMT Horizontal Mounting Type
2 No. of Pos.	10, 30, 40, 50, 60	5 Specifications	(00) : Standard (1,000pcs)
3 Contact Pitch	0.5mm		

## Connector Dimensions



Detailed View a



Note 1 : The dimensions in parenthesis are for reference.

Note 2 : The coplanarity of the contact and retention tab lead should be 0.1mm Max.

Note 3 : Packaged in tape and reel. Check the packaging specifications for details.

Note 4 : Sink holes may be added for improvements.

Note 5 : This product is halogen-free.

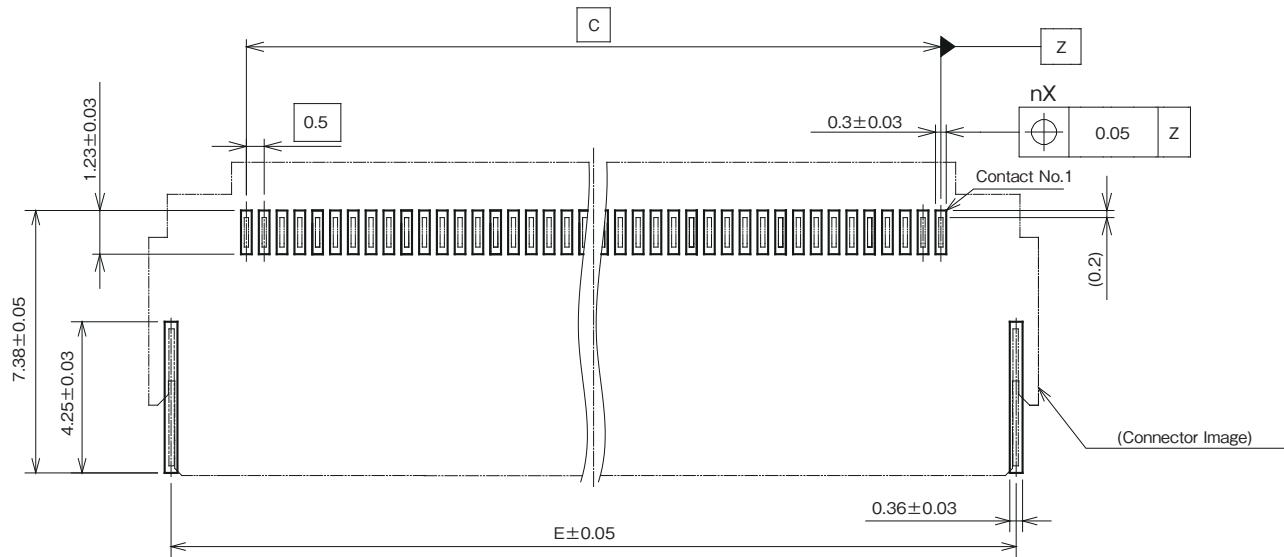
(Br : 900ppm maximum, Cl : 900ppm maximum, Cl + Br combined : 1,500ppm maximum)

Unit : mm

Part No.	HRS No.	No. of Pos.	A	B	C	D	Purchase Unit (##) : (00)
FH69-10S-0.5SH	CL0580-5003-0-00	10	9.98	8.7	4.5	5.57	1,000pcs per reel
FH69-20S-0.5SH	Under Planning (Note)	20	14.98	13.7	9.5	10.57	
FH69-30S-0.5SH	CL0580-5004-0-00	30	19.98	18.7	14.5	15.57	
FH69-40S-0.5SH	CL0580-5006-0-00	40	24.98	23.7	19.5	20.57	
FH69-50S-0.5SH	CL0580-5008-0-00	50	29.98	28.7	24.5	25.57	
FH69-60S-0.5SH	CL0580-5007-0-00	60	34.98	33.7	29.5	30.57	

Note : Products without HRS No. are currently being planned for development. Please contact a Hirose representative regarding questions on pin count variation development.

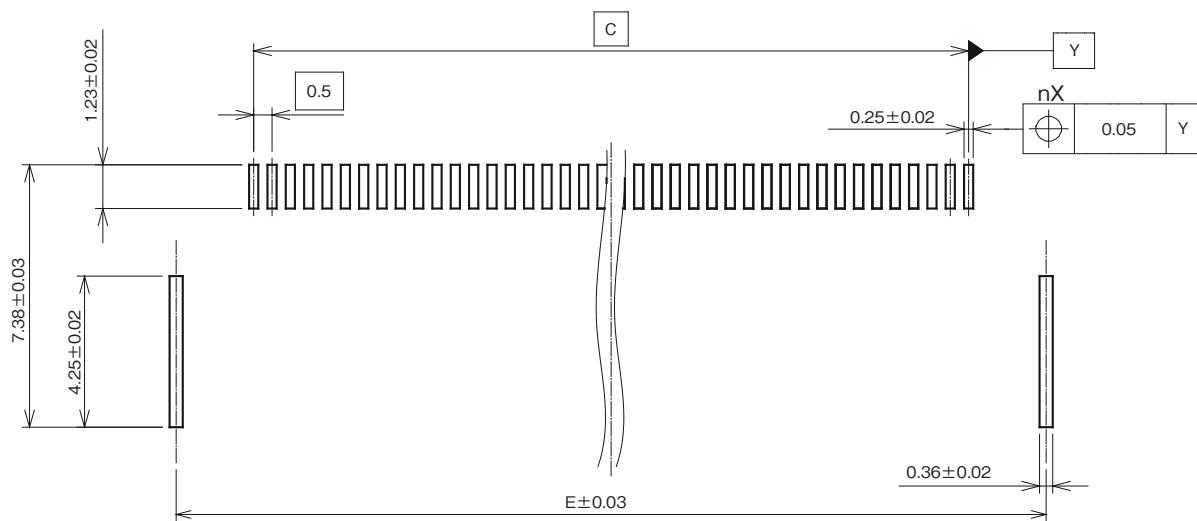
## ● Recommended PCB Layout



Note : 'n' indicated the number of positions.

\*FH69 has a dedicated land pattern; however, the land patterns of 0.5 mm pitch standard products FH28/FH28K/FH52E/FH52K/FH52T/FH75 can also be used with FH69.

## ● Recommended Metal Mask Dimensions



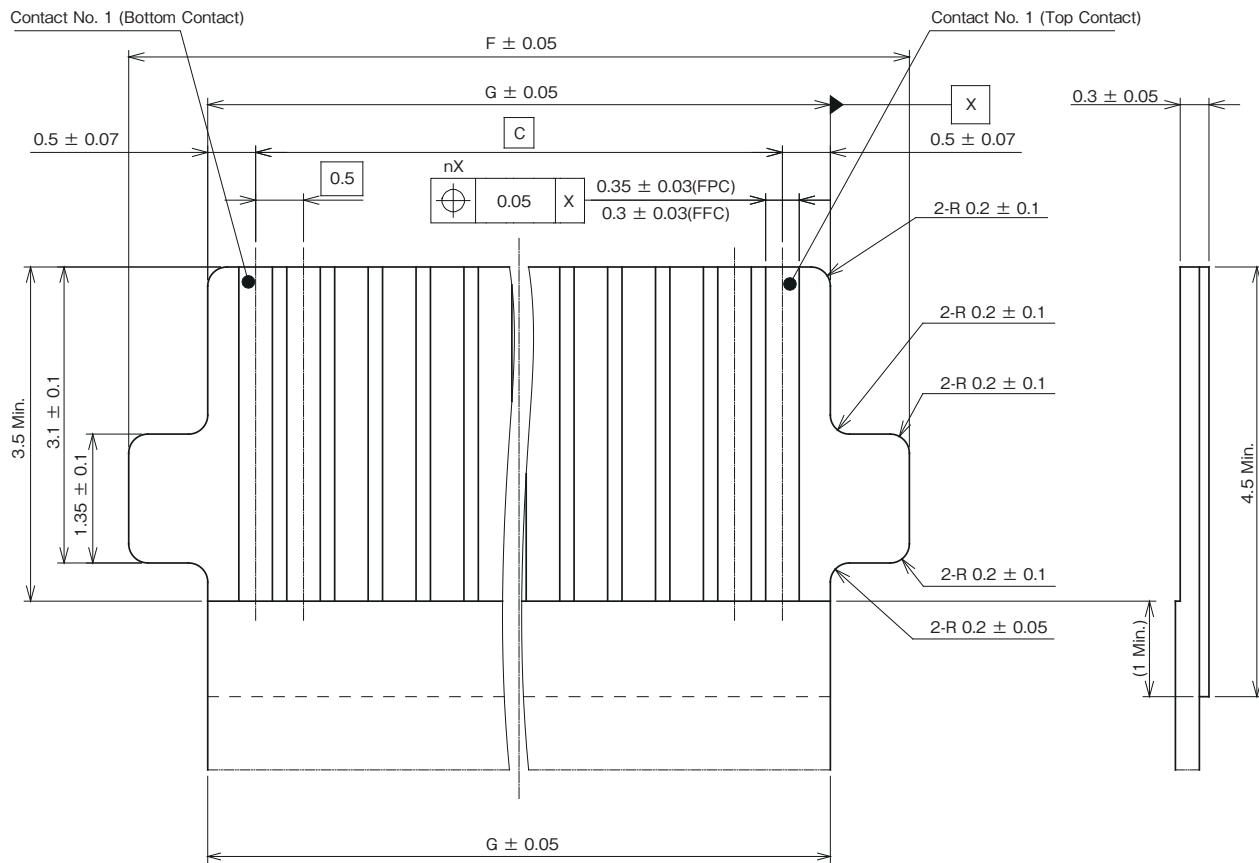
(Recommended Metal Mask Thickness : t=0.12)

Note : 'n' indicated the number of positions.

Part No.	HRS No.	No. of Pos.	C	E	Unit : mm
<b>FH69-10S-0.5SH</b>	CL0580-5003-0-00	10	4.5	8.73	
<b>FH69-20S-0.5SH</b>	Under Planning (Note)	20	9.5	13.73	
<b>FH69-30S-0.5SH</b>	CL0580-5004-0-00	30	14.5	18.73	
<b>FH69-40S-0.5SH</b>	CL0580-5006-0-00	40	19.5	23.73	
<b>FH69-50S-0.5SH</b>	CL0580-5008-0-00	50	24.5	28.73	
<b>FH69-60S-0.5SH</b>	CL0580-5007-0-00	60	29.5	33.73	

Note : Products without HRS No. are currently being planned for development. Please contact a Hirose representative regarding questions on pin count variation development.

## Recommended FPC/FFC Layout



Note : 'n' indicates the number of positions.

Part No.	HRS No.	No. of Pos.	C	F	G
FH69-10S-0.5SH	CL0580-5003-0-00	10	4.5	7.15	5.5
FH69-20S-0.5SH	Under Planning (Note)	20	9.5	12.15	10.5
FH69-30S-0.5SH	CL0580-5004-0-00	30	14.5	17.15	15.5
FH69-40S-0.5SH	CL0580-5006-0-00	40	19.5	22.15	20.5
FH69-50S-0.5SH	CL0580-5008-0-00	50	24.5	27.15	25.5
FH69-60S-0.5SH	CL0580-5007-0-00	60	29.5	32.15	30.5

Note : Products without HRS No. are currently being planned for development. Please contact a Hirose representative regarding questions on pin count variation development.

## Recommended FPC/FFC Construction

### ● FPC

FPC : Flexible Printed Circuit

Material Name	Material	Thickness (μm)
Cover Film Layer	Polymide 1mil	(25)
Cover Adhesive	1/2 oz	(18)
Surface Treatment	0.2μm thick gold plated over 1 to 5μm thick nickel underplating	3
Copper Foil	Cu 1 oz	35
Base Adhesive	Thermosetting Adhesive	25
Base Film	Polymide 1 mil	25
Reinforcement Adhesive	Thermosetting Adhesive	30
Reinforcement Film	Polymide 7 mil	175
	Total	293

### ● FFC

FFC : Flexible Flat Cable

Material Name	Material	Thickness (μm)
Polyester Film		(12)
Adhesive	Thermoplastic Polyester	(30)
Gold Plated Anneal Copper Foil		35
Adhesive	Polyester	30
Polyester		12
Adhesive	Polyester	30
Stiffener	Polyester	188
	Total	295

\*The allowable thickness tolerance is approx. 20μm.

Note 1 : This is a reference specification for the FH69 Series FPC/FFC construction ( $t=0.3 \pm 0.05\text{mm}$ ).

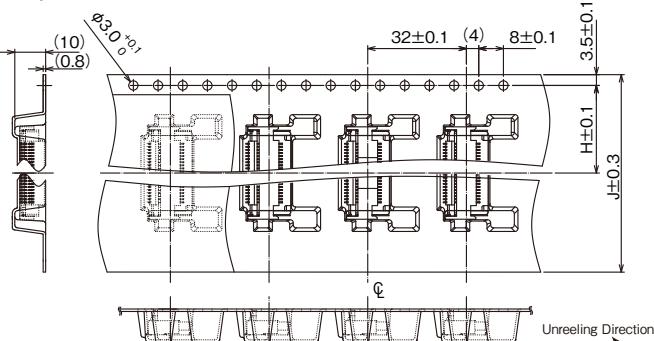
The thickness of the FPC/FFC mated portion should be  $0.3 \pm 0.05\text{mm}$  in reference to the construction materials.

Note 2 : Contact an FPC/FFC maker for details on component construction.

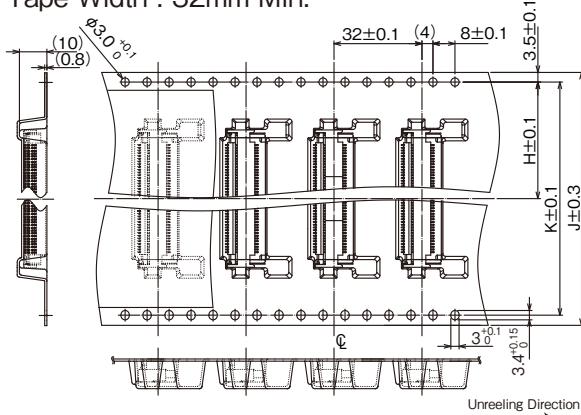
## Packaging Specifications

### ● Embossed Carrier Tape Dimensions

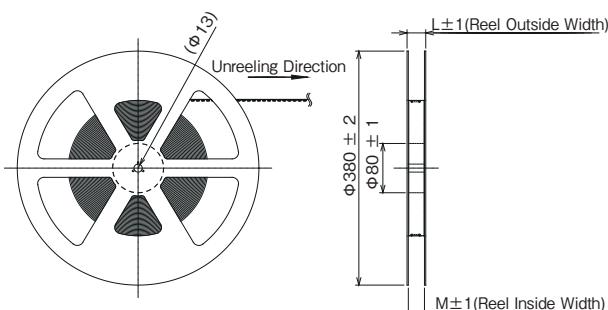
Tape Width : 24mm Max.



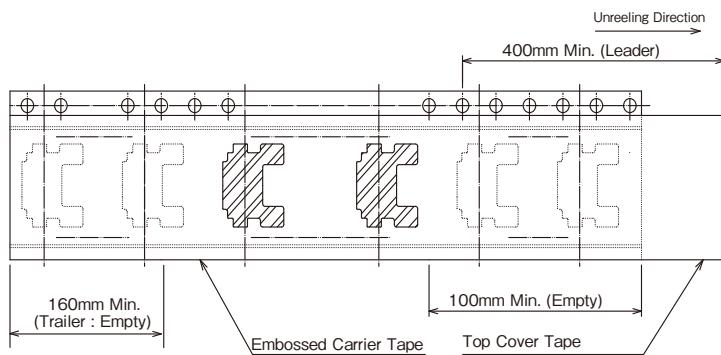
Tape Width : 32mm Min.



### ● Reel Dimensions



### ● Leader, Trailer Dimensions



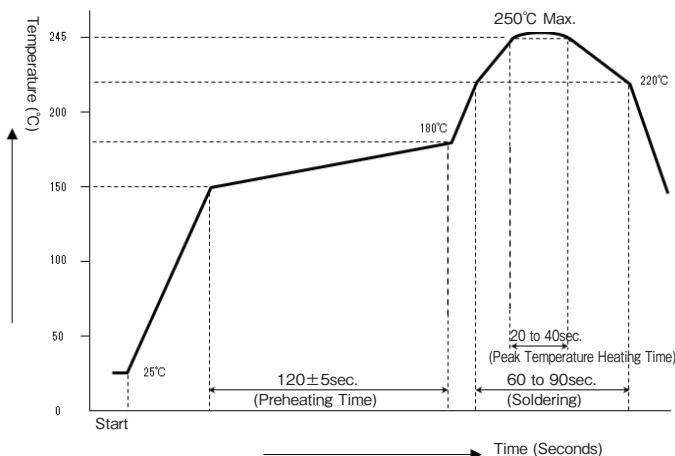
Note : This packaging meets JIS C 0806 and IEC 60286-3 (Packing of Components for Automatic Handling) standards.

Unit : mm

Part No.	HRS No.	No. of Pos.	H	J	K	L	M
FH69-10S-0.5SH	CL0580-5003-0-00	10	11.5	24.0	-	29.4	25.4
FH69-20S-0.5SH	Under Planning (Note)	20	14.2	32.0	28.4	37.4	33.4
FH69-30S-0.5SH	CL0580-5004-0-00	30	20.2	44.0	40.4	49.4	45.4
FH69-40S-0.5SH	CL0580-5006-0-00	40	20.2	44.0	40.4	49.4	45.4
FH69-50S-0.5SH	CL0580-5008-0-00	50	26.2	56.0	52.4	61.4	57.4
FH69-60S-0.5SH	CL0580-5007-0-00	60	26.2	56.0	52.4	61.4	57.4

Note : Products without HRS No. are currently being planned for development. Please contact a Hirose representative regarding question on pin count variation development.

## Temperature Profile



### Applicable Conditions

Solder Method : Reflow, IR/Hot air

Environment : Room Air

Solder Composition

: Paste SN/3.0Ag/0.5Cu

(Senju Metal Industry, co. Ltd Part Number :  
M705-221CM5-42-10.5)

Test Board : Board materials and size : Glass epoxy 80x100x1.6mm  
As listed on "Recommended Land Dimensions"

Metal Mask : Recommended thickness and aperture dimensions  
As listed on "Recommended Metal Mask Dimensions"

This temperature profile is for the above conditions.

The temperature profile may vary depending on the type of cream solder, the manufacturer, the board size and other conditions such as mounting materials. Please check the mounting status before use.

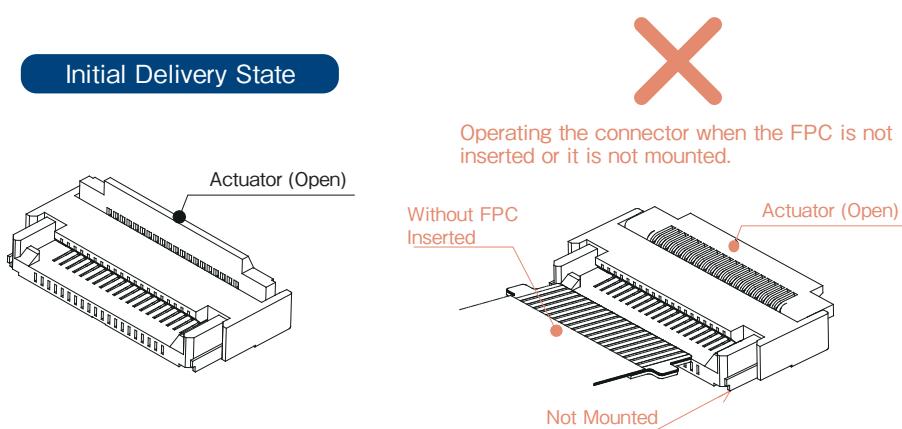
## Connector Operation and Precautions

### 【Operating Method】

Please use this connector after confirming the following operation instructions in order to prevent connector or FPC damage and contact failure (incomplete mating, FPC pattern disconnection). This connector is compatible with both FPC and FFC but only FPC is listed for convenience.

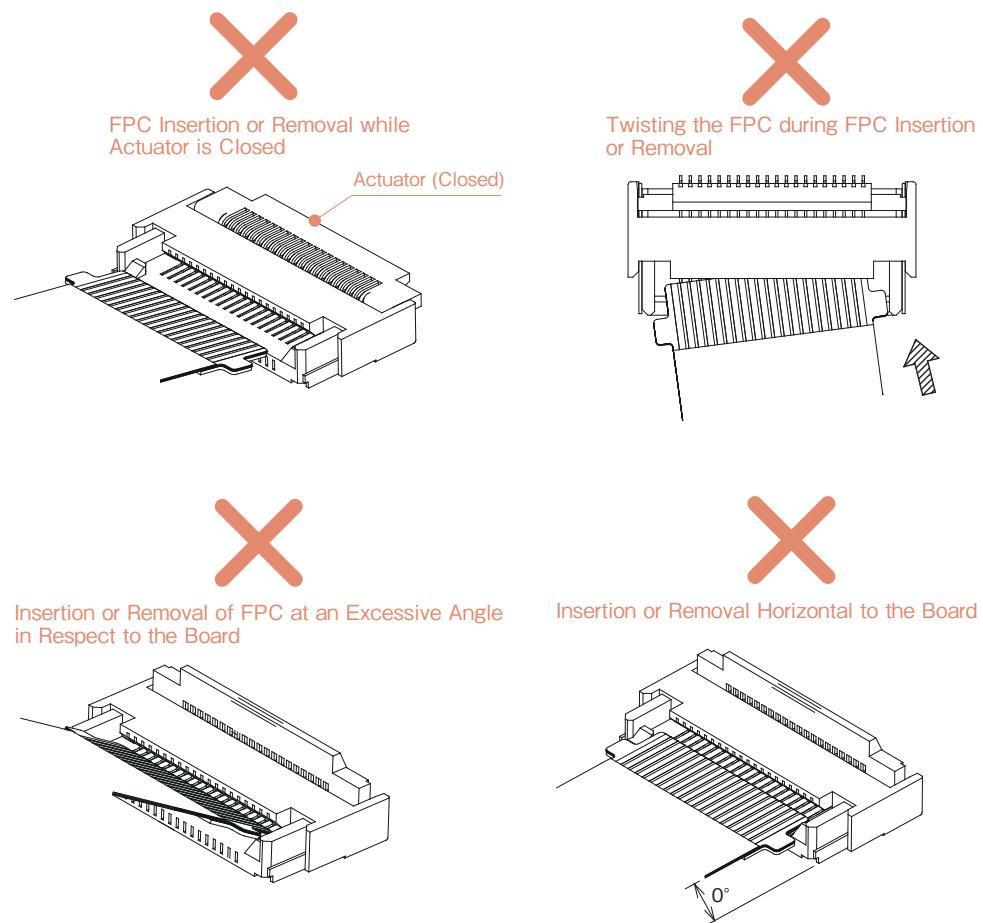
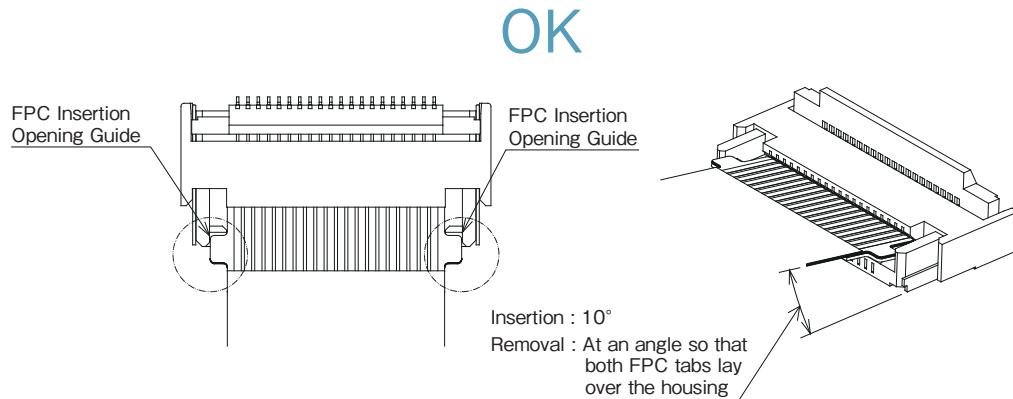
#### 1. Initial Delivery State

Since the product is delivered with the actuator open, there is no need to operate the actuator before FPC insertion.



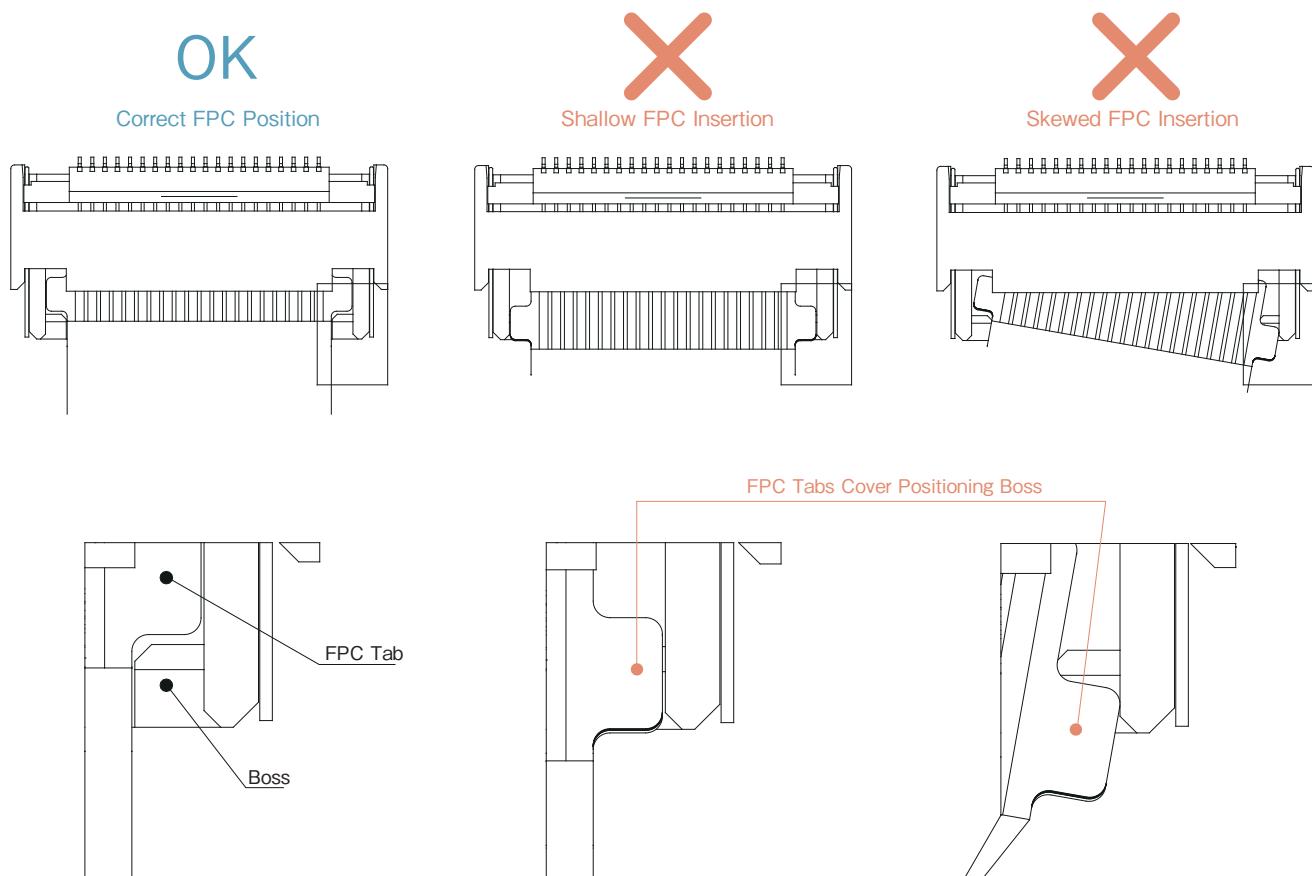
## 2. FPC Insertion and Extraction Method

- Insert the FPC fully at a 10° upward angle in respect to the board. Position both FPC tabs to the insertion opening guide and then insert completely.
- When removing the FPC, pull it out upward in a diagonal direction so that both tabs lay over the housing boss.



### 3. Confirm Actuator Locking After FPC Insertion

The FPC position is determined using the FPC positioning boss on the housing. After FPC insertion is completed and the actuator is locked, check whether both FPC tabs are in the below indicated positions.

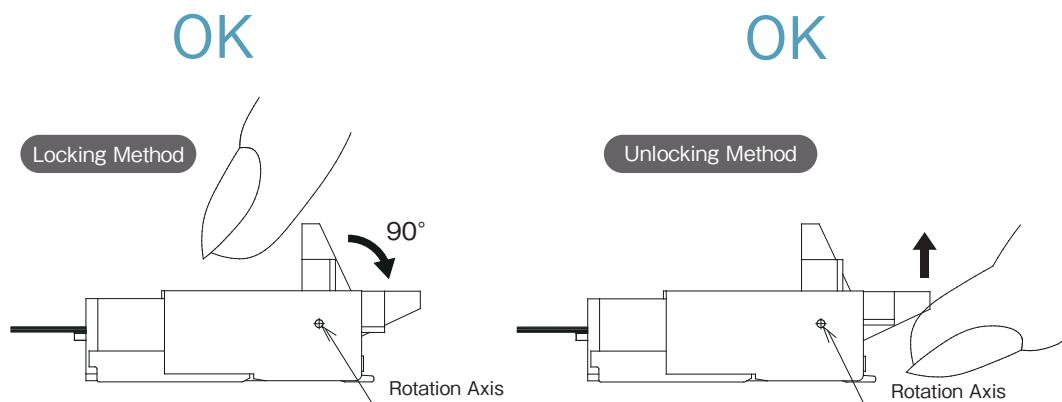


### 4. Actuator Locking and Release Method

The actuator rotates at its center.

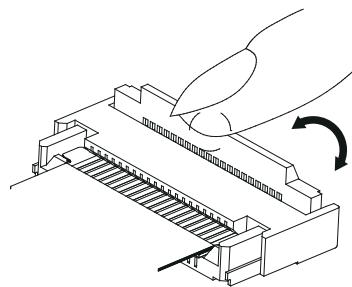
**Locking:** After inserting the FPC, operate the actuator and rotate it 90°.

**Release:** Slowly raise the actuator.



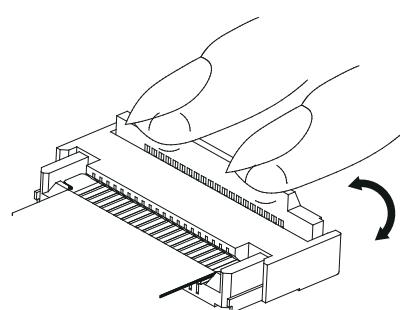
OK

Operate the Actuator Near its Center

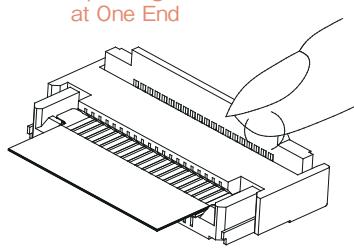


OK

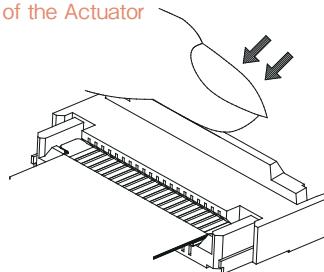
Operating at Both Ends of the Actuator at the Same Time



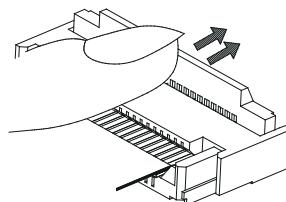
Operating the Actuator at One End



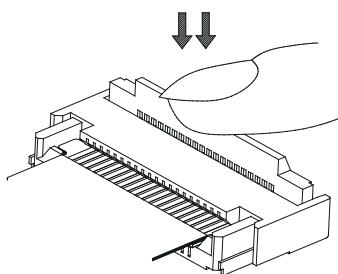
A Load in the Opposite Direction of the Actuator



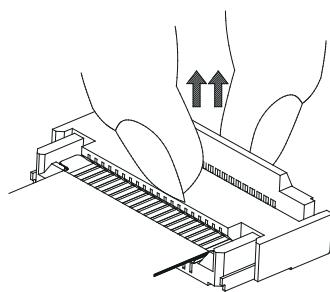
Pushing Horizontally to Lock



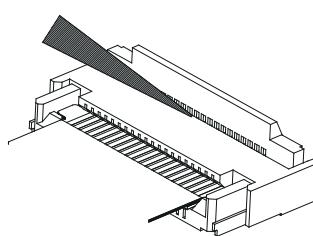
Pushing Down Vertically to Lock



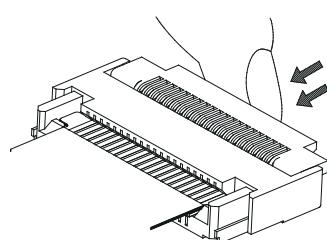
Lifting Up the Actuator



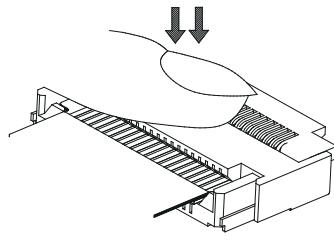
Operation Using Sharp Tools



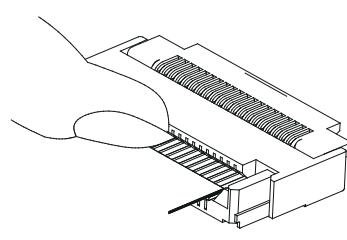
Pushing on the Actuator Towards the Connector Body



Applying Excessive Force to the Insulation Case



Operating From FPC Insertion Side



## Precautions

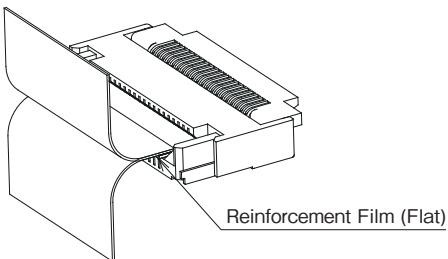
### 【PCB Layout Precautions】

Design the board layout so that no load is applied to the connector FPC.

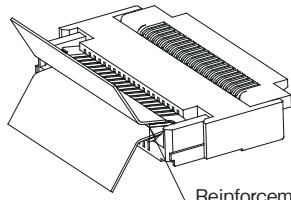
- Route the FPC so that it has leeway and is not pulled. Make sure that the reinforcing film is horizontal to the board surface.
- Do not place interfering components under the FPC.
- Check with the FPC manufacture regarding FPC flexibility.
- When designing the board/layout, ensure that there is enough space to operate and close the actuator.
- Consult with a Hirose representative about usage of FPC size and shape different from what is recommended.

**OK**

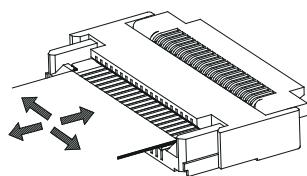
No Load on Reinforcement Film



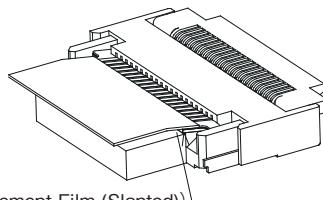
Load on Reinforcement Film



Load on FPC



Case and Components Interfering with FPC



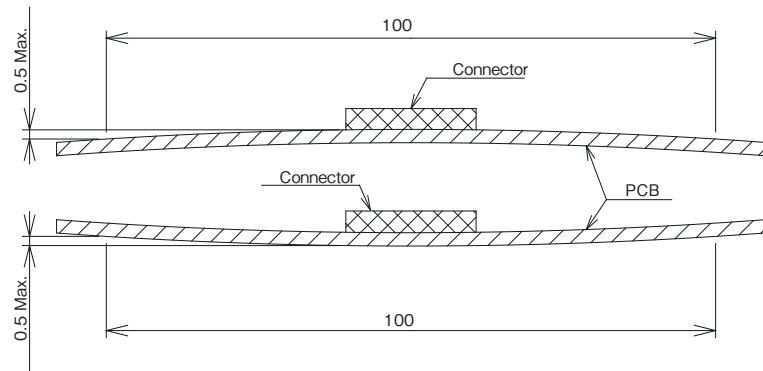
### 【Board Mounting Precautions】

- Please check the recommended mounting PCB land shape, metal mask opening and FPC. When using a pattern different from the recommendations, check the mounting condition before use.
- Check the mounting condition before use when there is silk printing below the connector.
- The reflow conditions must be within the specifications. Mounting conditions may be affected by the type of solder paste, manufacturer, PCB size and other mounted components. Please check the mounting conditions before use.
- Keep board warpage to a minimum. The coplanarity of this connector is 0.1mm Max. Soldering failure may occur due to excessive board warpage.
- When mounting the FPC, design a reinforcing plate for easy handling. Reinforcing plates made of glass epoxy with a thickness of 0.3mm Min. are recommended.
- Do not apply excessive force to the connector before mounting, such as by pulling the emboss out from the reel or suctioning the connector from the emboss. (0.5N Max.)

## [Handling Precautions After PCB Mounting]

Board warpage may place a load to the connector and result in damage.

- Avoid placing a load to the board during the assembly processes such as splitting a board into several pieces or screwing the board.
- The warpage of a 100mm wide board should be 0.5mm or less.



## [Manual Soldering]

- Do not perform manual soldering with the FPC inserted into the connector.
- Do not heat the connector excessively or let the soldering iron touch any parts other than the contact leads.
- Do not use excessive solder (or flux).

## While Taking into Consideration

Specifications mentioned in this catalog are reference values.

When considering to order or use this product, please review the Drawing and Product Specifications sheets.

Use an appropriate cable when using the connector in combination with cables.

If considering usage of a non-specified cable, please contact your sales representative.

If assembly process is done by jigs & tools which are not identified by Hirose, the warranty of the product may be affected.

If considering usage for below mentioned applications, please contact your sales representative.

In cases where the application will demand a high level of reliability, such as automotive, medical instruments, public infrastructure, aerospace/defense etc. Hirose must review before assurance of reliability can be given.

HIROSE



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<https://www.hirose.com>